



Unlock Peak Performance

With KingBank Storage & Memory



- Over 10 years rooted in storage, powering the AI era.

2003 ~ 2026

- Company Introduction

Shenzhen KingBank Technology Co., Ltd. (formerly known as Shenzhen Qianhai Weishengda E-commerce Co., Ltd. established in 2014 along with the brand name "KingBank" registered), turned into a self-branded company in 2021, striking a place in the market with solid-state drive-led peripheral series products. Over the years, we have equipped ourselves with the most advanced and rigorous testing process in the industry, providing high-performance gadgets such as SSDs, memory RAMs and portable digital accessories.

Headquartered in Shenzhen, a place abounding with opportunities, we boast great resources to develop and manufacture efficient hardware peripherals to meet a market in high demand. Exploring the online sales channels such as JD.com early on, we have bettered our service centers in terms of inquiries, after-sales, warranty and maintenance, featuring instantly responsive and supportive services.

We aim to deliver fulfilling innovations to upgrade your desktop devices. Thus, we value highly users' feedback to constantly upgrade our products and designs. The philosophy of putting people first is carved in our business concept, so we take customers first in the business and employees first in the workplace, winning us reliability and mutual care in return. For years, we have gained through strict self-management a wide recognition on high-quality goods and satisfying after-sales service.

Going forward, we will keep providing a growing series of trustworthy products and service, positioning KingBank to be a globally leading hardware peripheral brand.

We are KingBank, and we are here to build you a magnificent memory bank.

30+

Covers countries and regions

5M+

Global Users

20+ year

Experience in the storage industry

• Core product lines



DRAM

Ultra-low latency & high throughput, consistent performance under heavy multi-task workloads Precise cache scheduling elevates the upper limits of system responsiveness and durability The foundational computing buffer for full scenarios: servers, industrial controllers and terminals



SSD

High-capacity & high-density flash memory with sustained high-speed read/write performance without speed degradation Intelligent wear leveling delivers long-term stability to safeguard data security Storage solution compatible with full scenarios: AI, industrial, consumer and data center applications

• Core Advantages



Directly sourced first-tier brand flash dies & chips

Stable, Authentic, High-quality Reliable, Swift Delivery



Premium PCB and IC Components

Durable, Reliable, Stable, Energy-saving, Quality Guaranteed



Verified & Tested on Mainstream Motherboards

Compatibility, Stability, Reliability, Plug-and-Play



Worry-free after-sales service, effortless support

Free replacement for manufacturing defects

• Enterprise Cooperation



• Qualification Certification

China National
High-Tech Firm



Certified Niche Innovative
SMEs in Shenzhen



Shenzhen Recognized
Innovative SME



CE



FCC



RoHS



UKCA



Speed Up Your System-Upgrade Your RAM !

SoarBlade KFRW/KFRB DDR5 RGB Series

DRAM



- ▶ Adopts premium SK Hynix A/M-die memory chips for ultimate reliability.
- ▶ High-grade multi-layer PCB ensures ultra-stable signal transmission.
- ▶ 2mm thick heat spreader delivers continuous cooling and sustained peak performance.
- ▶ Syncable RGB lighting creates immersive esports gaming ambiance.

Model:	DDR5 DIMM
Interface:	288-Pin UDIMM
Frequency:	6000/6400/6800/7600/8000/8400MT/s
Capacity:	32GB(16GBx2)/48GB(24GBx2)/64GB(32GBx2)/96GB(48GBx2)
Timing:	CL26/CL32/CL32/CL36/CL36/CL38
Operating Voltage:	1.45V ~1.5V
Heatsink:	2.0mm
After-Sales Service:	Lifetime

Maximize Speed Minimize Wait-The Power of RAM !

SoarBlade KRRW/KRRB DDR4/DDR5 RGB Series

DRAM



- ▶ Adopts premium grade A/M-die from SK Hynix and genuine CXMT chips, delivering authentic first-tier manufacturer quality.
- ▶ High-quality multi-layer PCB board ensures more stable signal transmission.
- ▶ 2mm ultra-thick heat spreader enables continuous heat dissipation and sustained stable performance.
- ▶ Syncable RGB lighting delivers stunning immersive esports ambiance.

Model:	DDR4/DDR5 DIMM
Interface:	288-Pin UDIMM
Frequency:	3200/3600/4000MHz ; 6000/6400/6800/7200/7600MT/s
Capacity:	8GB/16GB/32GB ; 16GB(8GBx2)/32GB(16GBx2)/48GB(24GBx2) 64GB(32GBx2)/96GB(48GBx2)
Timing:	CL16/CL18/CL19 ; CL36/CL32/CL32/CL34/CL36
Operating Voltage:	1.35V~1.45V
Heatsink:	2.0mm
After-Sales Service:	Lifetime

Maximize Speed Minimize Wait-The Power of RAM !

SoarBlade KFXW/KFXB DDR4/DDR5 Heatsink Series

DRAM



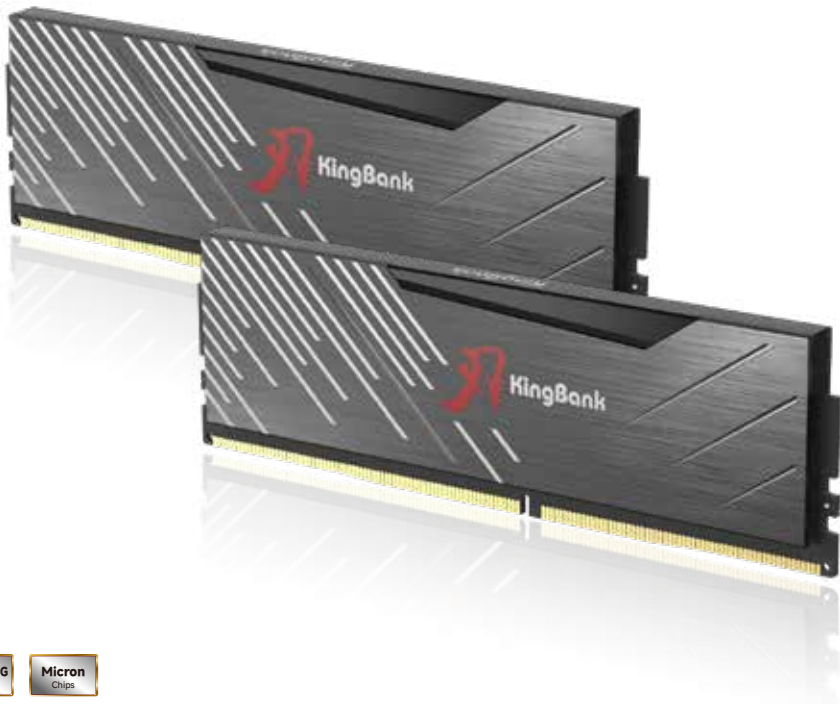
- ▶ Premium selected chips for stable & reliable operation
- ▶ Thick heat spreader design with immersive gaming aesthetic
- ▶ 2mm heavy heat sink for continuous cooling and lasting performance

Model:	DDR4/DDR5 DIMM
Interface:	288-Pin UDIMM
Frequency:	DDR4:3600MHz DDR5:6000/6400/6800/7200/7600/8000/8400MT/s
Capacity:	16GB(8GBx2); 32GB(16GBx2)/48GB(24GBx2)/96GB(48GBx2)
Timing:	DDR4:CL18; DDR5:CL26/CL32/CL32/CL34/CL36/CL36/CL38
Operating Voltage:	1.35~1.5V
Heatsink:	2.0mm
After-Sales Service:	Lifetime

Running Up To 6000MT/s~7200MT/s

SoarBlade KRXB DDR5 Heatsink Series

DRAM



- ▶ Premium selected chips for stability & full compatibility
- ▶ Sleek stylish heat spreader design for immersive gaming atmosphere
- ▶ 2mm thick heat sink for sustained cooling and durable performance

Model:	DDR5 DIMM
Interface:	288-Pin UDIMM
Frequency:	6000/6400/6800/7200MT/s
Capacity:	16GB(8GBx2)/32GB(16GBx2)/64GB(32GBx2)
Timing:	CL36/CL30/CL32/CL34/CL36
Operating Voltage:	1.35V~1.4V
Heatsink:	2.0mm
After-Sales Service:	Lifetime

Supports speeds ranging from 2666 to 6400 MT/s

KJXS DDR4/DDR5 Silver Heatsink Series

DRAM



- ▶ Premium selected chips with excellent heat resistance & durability
- ▶ Low-height heat sink, compatible with small motherboards
- ▶ 1mm thick heat spreader for constant cooling and long-lasting performance

Model:	DDR4/DDR5 DIMM
Interface:	288-Pin UDIMM
Frequency:	2666/3200/3600MHz ; 4800/5600/6000/6400MT/s
Capacity:	8GB/16GB/32GB ; 16GB(8GBx2)/48GB(24GBx2)/64GB(32GBx2)
Timing:	CL19/CL16/CL18 ; CL40/CL46/CL36/CL32
Operating Voltage:	DDR4 1.2V~1.35V ; DDR5 1.1V~1.4V
Heatsink:	1.0mm
After-Sales Service:	Lifetime

Running Up To 2666/3200/3600MHz

KJIB DDR4 (Intel) Heatsink Series

DRAM



- ▶ Intel Platform Exclusive Memory
- ▶ Intel-tuned for enhanced stability
- ▶ Plug-and-play, hassle-free installation & upgrade
- ▶ Intel-standard voltage design for lasting reliability

Model:	DDR4 DIMM
Interface:	288-Pin UDIMM
Frequency:	2666/3200/3600MHz
Capacity:	8GB/16GB/16GB(8GBx2)/32GB(16GBx2)
Timing:	CL19/CL22/CL18
Operating Voltage:	1.2V~1.35V
Heatsink:	1.0mm
After-Sales Service:	Lifetime

Running Up To 4800/5600/6400/7200MT/s

KDUN/KDSN DDR5 U-DIMM/SO-DIMM Series

DRAM



- ▶ Perfect for office & daily gaming PCs, fits most scenarios
- ▶ Broad compatibility, plug-and-play
- ▶ Stable performance with minimal failure risk
- ▶ Small form factor, easy to install, compatible with low-height heatsinks

Model:	DDR5 DIMM
Interface:	288-Pin U-DIMM; 262-Pin SO-DIMM
Frequency:	4800/5600/6400/7200MT/s
Capacity:	16GB/24GB/32GB/48GB
Timing:	CL40
Operating Voltage:	1.1V ~1.45V
After-Sales Service:	Lifetime

Running Up To 2666/3200MHz

KDUN/KDSN DDR4 U-DIMM/SO-DIMM Series

DRAM



- ▶ Perfect for office & daily gaming PCs, fits most scenarios
- ▶ Broad compatibility, plug-and-play
- ▶ Stable performance with minimal failure risk
- ▶ Small form factor, easy to install, compatible with low-height heatsinks

Model:	DDR4 DIMM
Interface:	288-Pin U-DIMM; 260-Pin SO-DIMM
Frequency:	2666/3200MHz
Capacity:	4GB/8GB/16GB/32GB
Timing:	CL17/CL19/CL22
Operating Voltage:	1.2V
After-Sales Service:	Lifetime

Running Up To 1333/1600MHz

KDUN/KDSN DDR3/3L U-DIMM/SO-DIMM Series

DRAM



- ▶ Perfect for office & daily gaming PCs, fits most scenarios
- ▶ Broad compatibility, plug-and-play
- ▶ Stable performance with minimal failure risk
- ▶ Small form factor, easy to install, compatible with low-height heatsinks

Model:	DDR3/DDR3L DIMM
Interface:	240-Pin U-DIMM; 204-Pin SO-DIMM
Frequency:	1333/1600MHz
Capacity:	2GB/4GB/8GB
Timing:	CL11
Operating Voltage:	1.35V~1.5V
After-Sales Service:	Lifetime

Flagship performance, high-speed read and write

SoarBlade KP 270-PCIe 4.0 2280 SSD

Read to **7500** MB/s, Write to **6800** MB/s



- ▶ Perfect for office & daily gaming PCs, fits most scenarios
- ▶ Broad compatibility, plug-and-play
- ▶ Stable performance with minimal failure risk
- ▶ Small form factor, easy to install, compatible with low-height heatsinks

Capacity:	2TB/1TB
Interface Protocol:	M.2 2280 PCIe 4.0 NVMe 1.4
Chips:	TLC
Controller:	InnoGrit
Sequential read/write:	Read 7500MB/s; Write 6800MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, :non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	1200TBW/600TBW
Warranty:	5 year

Flagship performance, high-speed read and write

KP 260 Plus-PCIe 4.0 2280 SSD

Read to **7100** MB/s, Write to **6500** MB/s



- ▶ Fast data loading for AAA games, editing, modeling and rendering
- ▶ Multi-task without lag, run multiple programs & files at once
- ▶ High-quality controller & premium chips for stable long-term use

Capacity:	2TB/1TB/512GB
Interface Protocol:	M.2 2280 PCIe 4.0 NVMe 1.4/2.0
Chips:	TLC
Controller:	InnoGrit / Maxio
Sequential read/write:	KP260 /KP260Pro: Read 5000MB/s; Write 4500MB/s KP260 Plus: Read 7100MB/s; Write 6500MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	1200TBW/600TBW/300TBW
Warranty:	5 year

Flagship performance, high-speed read and write

KP 230-PCIe 3.0 2280 SSD

Read to **3500** MB/s, Write to **3200** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	2TB/1TB/512GB/256GB/128GB
Interface Protocol:	M.2 2280 PCIe 3.0 NVMe 1.4
Chips:	TLC
Controller:	InnoGrit / Maxio
Sequential read/write:	KP230 1TB: Read 3500MB/s; Write 3200MB/s KP230 512GB: Read 3300MB/s; Write 2500MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	1200TBW/600TBW/300TBW/150TBW/70TBW
Warranty:	5 year

Flagship performance, high-speed read and write

KP 160 Plus-PCIe 4.0 2280 SSD

Read to **7400** MB/s, Write to **6300** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	2TB/1TB
Interface Protocol:	M.2 2280 PCIe 4.0 NVMe 1.4/2.0
Chips:	QLC
Controller:	InnoGrit / Maxio
Sequential read/write:	KP160: Read 4900MB/s; Write 4300MB/s KP160 Plus: Read 7400MB/s; Write 6300MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	600TBW/350TBW
Warranty:	5 year

Flagship performance, high-speed read and write

KP 130-PCIe 3.0 2280 SSD

Read to **3500** MB/s, Write to **2700** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	2TB/1TB/512GB
Interface Protocol:	M.2 2280 PCIe 3.0 NVMe 1.4
Chips:	QLC
Controller:	Maxio
Sequential read/write:	KP130: Read 3500MB/s; Write 2700MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	600TBW/350TBW/179TBW
Warranty:	5 year

Flagship performance, high-speed read and write

KM 210-m.2 2280 SATA 3.0 (6Gb/s)SSD

Read to **550** MB/s, Write to **450** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	1TB/512GB/256GB/128GB
Interface Protocol:	m.2 2280 SATA 3.0 (6Gb/s)
Chips:	TLC
Controller:	Marvell/Maxio
Sequential read/write:	KM210: Read 550MB/s; Write 450MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	80×22×2.5mm
TBW (Max. capacity):	600TBW/300TBW/150TBW/70TBW
Warranty:	3 year

Flagship performance, high-speed read and write

KP 310-SATA 3.0 2.5-inch SSD

Read to **560** MB/s, Write to **510** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	2TB/1TB/512GB
Interface Protocol:	SATA III (6Gb/s)
Chips:	QLC
Controller:	Marvell/Maxio
Sequential read/write:	KP310: Read 560MB/s; Write 510MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	100x70x7mm
TBW (Max. capacity):	600TBW/350TBW/179TBW
Warranty:	3 year

Flagship performance, high-speed read and write

KP 320/330-SATA 3.0 2.5-inch SSD

Read to **550** MB/s, Write to **460** MB/s



- ▶ Broad compatibility, plug-and-play for old laptops & desktops
- ▶ Stable power input, no extra cables, fast installation and removal
- ▶ Sufficient cooling space for steady temperature under prolonged workloads

Capacity:	2TB/1TB/512GB
Interface Protocol:	SATA III (6Gb/s)
Chips:	TLC
Controller:	Marvell/Maxio
Sequential read/write:	KP320: Read 550MB/s; Write 460MB/s KP330: Read 550MB/s; Write 460MB/s
Operating Temperature:	0°C~85°C
Storage Temperature:	-40°C~85°C (Designed for professional environments, non-condensing)
Shock Resistance:	1500G/0.5ms
Dimensions (L×W×H):	100x70x7mm
TBW (Max. capacity):	1200TBW/600TBW/300TBW
Warranty:	3 year

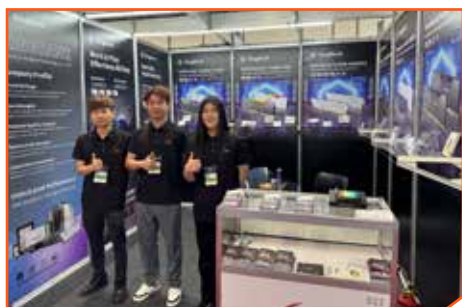


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COMPUTEX TAIPEI 2025

COMPUTEX TAIPEI 2024

COMPUTEX TAIPEI 2026



Eletrolar Show 2026



COMPUTEX TAIPEI 2025



Global Sources Hong Kong Show 2024

Global Business Footprint

Asia

Russia、South Korea
India、Singapore
Malaysia、Thailand
Vietnam、Indonesia
Philippines、Kazakhstan
Cambodia、Iran
Uzbekistan

Europe

Germany
United Kingdom
France、Italy、Spain
Poland、Netherlands
Czech Republic
Romania

North America

United States
Canada

Latin America

Brazil、Mexico
Chile、Colombia

Middle East

UAE、Saudi Arabia

Africa

Egypt、South Africa
Tunisia

Oceania

Australia、New Zealand

Superior Quality Rooted in Core Chips



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Disclaimer

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Website